

Mighty-Bond® Intersystem Bonding Bridge



Intersystem Bonding Bridge used inside or outside of an enclosure or panel board. 3-Equipment bonding terminations. Meets the requirement of NEC Article 250.94. Patented. US Patent 8,809,680; D626,087.

File No. E20412

Brass with Stainless Steel Hardware

Catalog Number	Trade Size	Wire Capacity	Unit Qty.	Std. Pkg.
IGB-050	1/2"	14 to 4	25	100
IGB-075	3/4"	14 to 4	25	100

Mighty-Bond® Intersystem Ground Rod Bridge Clamps



Ground Rod Bridge Clamps used as an intersystem bonding means by utilizing 4-terminal points for connecting communication systems to the same electrical grounding electrode/rod. Meets the requirement of NEC Article 250.94. Direct Burial Rated. Patented. US Patent D648,281.

File No. E20412

Bronze with Stainless Steel Hardware



Catalog Number	Ground Rod Size		Rebar Size		Copper Conductor Size Under Ground Rod	
	Min.	Max.	Min.	Max.	Min.	Max.
IGBC-063	1/2"	5/8"	#3	#4	8 Stranded 8 Solid	2 Stranded 2 Solid
IGBC-075	5/8"	3/4"	#5	#6	4 Stranded 4 Solid	1/0 Stranded 2 Solid

Bronze with Stainless Steel Hardware *Continued*

Catalog Number	Terminal Conductor Size		Unit Qty.	Std. Pkg.
	Min.	Max.		
IGBC-063	14 Stranded	4 Stranded	25	100
	14 Solid	10 Solid		
IGBC-075	14 Stranded	4 Stranded	25	100
	14 Solid	10 Solid		